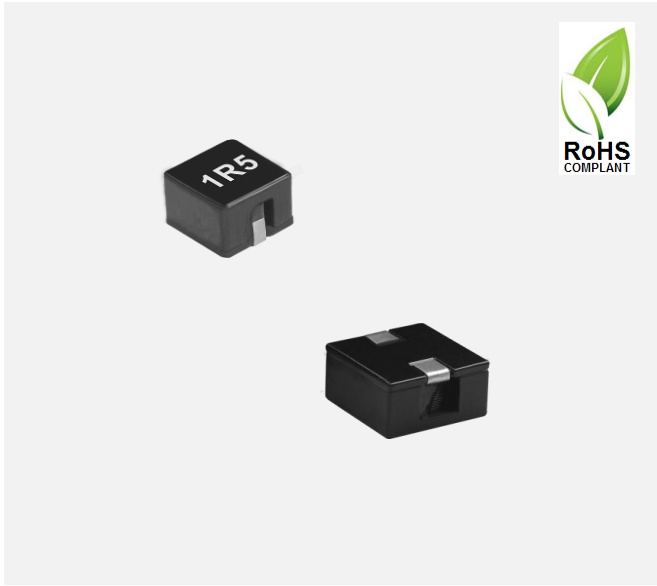


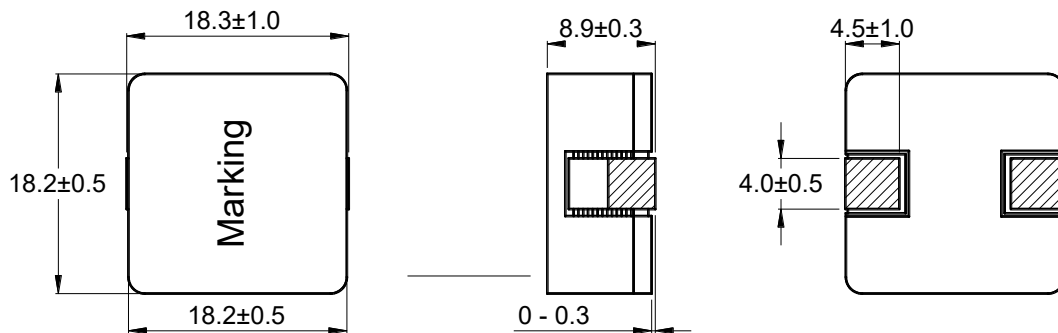
- FWP1809 Series



Outline: 产品概要

- Magnetic shielded structure: excellent resistance to electro magnetic interference(EMI)
磁屏蔽结构：抗电磁干扰(EMI)性能强
- Flat wire winding, achieve a low D.C. Resistance.
扁平线绕组，实现极低的直流电阻。
- Low loss, high efficiency, wide application frequency and application scope.
低损耗，高效率，应用频率宽，适用范围广。
- Lightweight design, save space, suitable for high density SMT.
轻薄型设计，节省空间，适合高密度贴装。
- Operating temperature : $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$
(Including coil's temperature rise)
工作温度： $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (包含线圈发热)

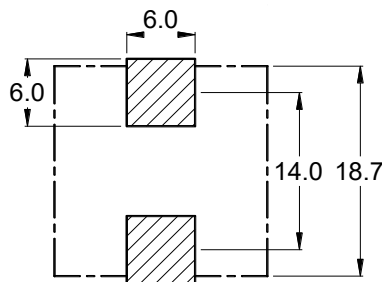
1 Appearance and dimensions (mm) 外形尺寸



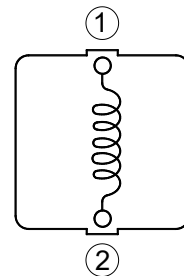
2 Marking 印字标识



3 Reference land pattern (mm) 参考基板尺寸



4 Schematic 原理图



- FWP1809 Series

5 Electrical characteristic

电气特性

Part No. 型号	Inductance (μH) 电感值 ※1 $\pm 20\%$	D.C.R. ($\text{m}\Omega$) 直流电阻		Saturation current (A) 饱和电流 ※2 Typical	Temperature rise current (A) 温升电流 ※3 Typical
		$\pm 10\%$			
FWP1809-R82M	0.82	0.54	0.59	65.0	41.5
FWP1809-1R3M	1.30	0.94	1.03	62.0	34.5
FWP1809-1R9M	1.90	1.20	1.30	52.0	32.5
FWP1809-2R6M	2.60	1.58	1.74	50.0	31.5
FWP1809-3R5M	3.50	3.10	3.40	37.0	22.5
FWP1809-4R5M	4.50	3.40	3.70	37.0	20.5
FWP1809-5R6M	5.60	3.70	4.10	33.0	19.0
FWP1809-6R8M	6.80	4.10	4.50	27.0	18.5
FWP1809-100M	10.0	6.90	7.60	21.5	15.0
FWP1809-220M	22.0	14.6	15.8	14.0	11.0

■ All data is tested based on 25°C ambient temperature.

所有数据基于环境温度 25°C 条件下测试。

※1 Inductance measure condition at 100kHz, 0.1V.

电感测试条件为 100kHz, 0.1V。

※2 Saturation current: the actual value of DC current when the inductance decrease 30% of its initial value.

饱和电流: 电感值下降其初始值的 30% 时所加载的实际直流电流值。

※3 Temperature rise current: the actual value of DC current when the temperature rise is $\Delta T 50^\circ\text{C}$ ($T_a = 25^\circ\text{C}$).

温升电流: 使产品温度上升到 $\Delta T 50^\circ\text{C}$ 时所加载的实际直流电流值 ($T_a = 25^\circ\text{C}$)。

※ Special remind: Circuit design, component placement, PWB size and thickness, cooling system and etc. all will affect the product temperature. Please verify the product temperature in the final application.

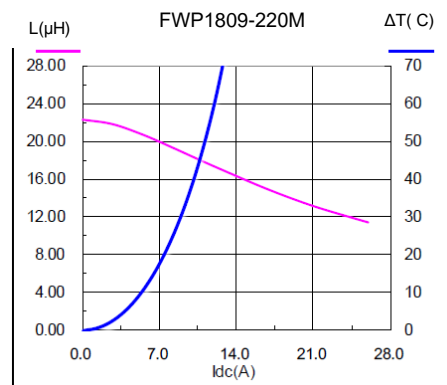
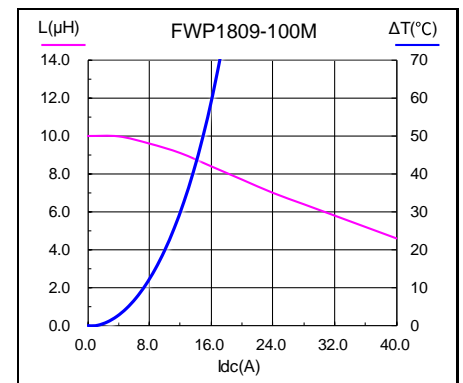
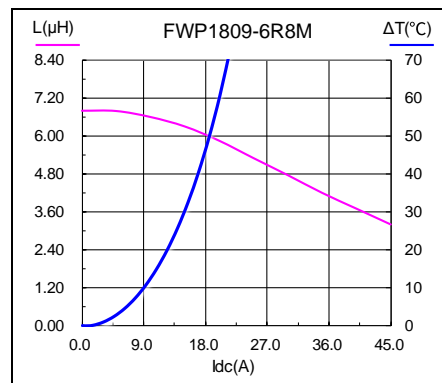
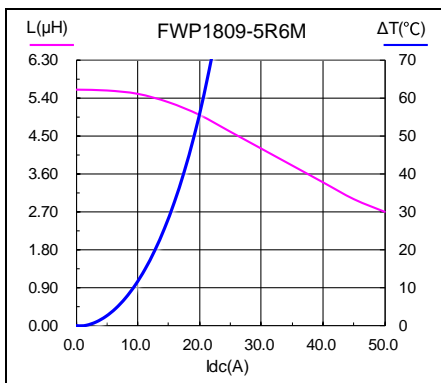
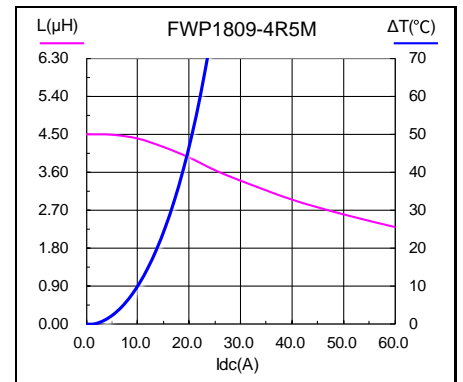
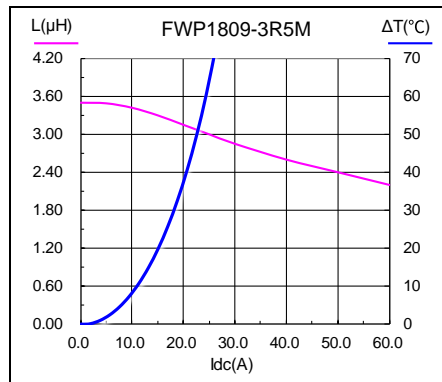
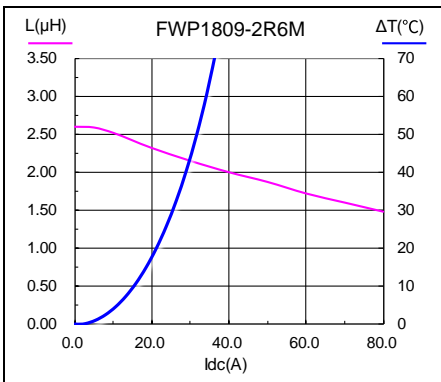
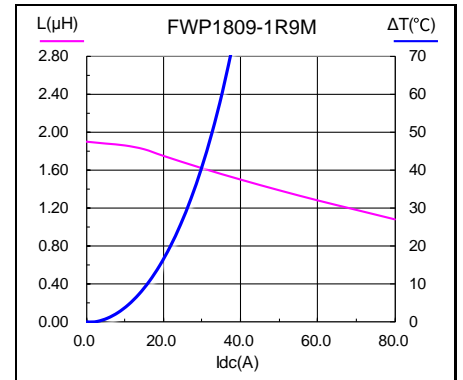
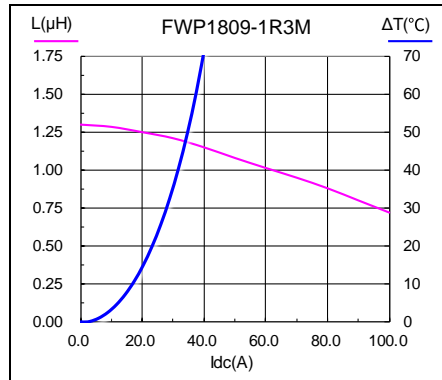
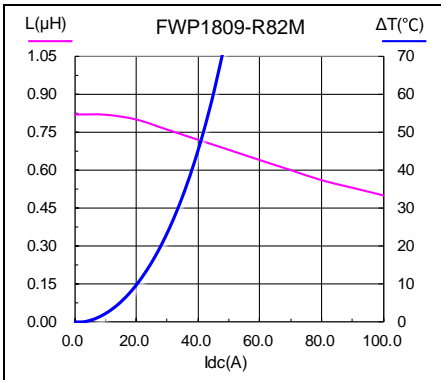
特别提醒: 线路设计, 组件布局, 印刷电路板(PWB)尺寸及厚度, 散热系统等均会影响产品温度。

请务必在最终应用时, 验证产品发热状况。

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6 Saturation current VS temperature rise current curve

饱和电流 VS 温升电流曲线



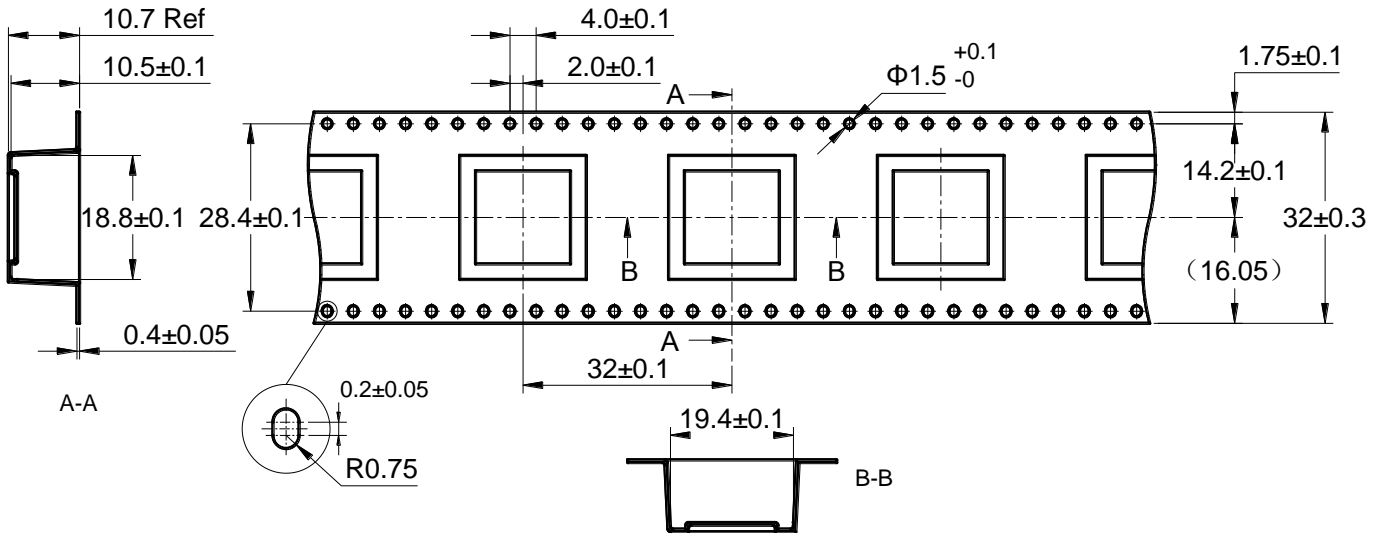
- FWP1809 Series

7 Packing specification

包装规格

7.1 Carrier tape dimensions (mm)

载带尺寸

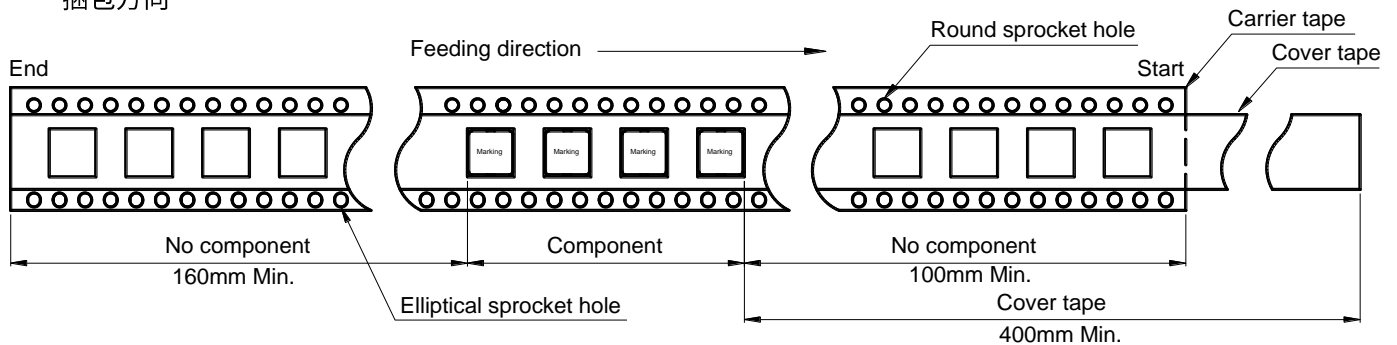


※ Packing is referred to the international standard IEC 60286-3.

包装参照国际标准 IEC 60286-3.

7.2 Tape direction

捆包方向



7.3 Cover tape peel off condition

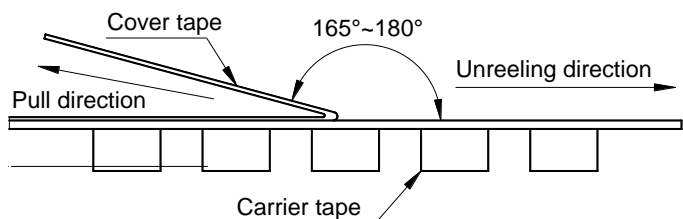
盖带剥离条件

■ Cover tape peel force shall be 0.1 to 1.3N.

盖带剥离力度为 0.1~1.3N。

■ Reference peel speed 300±10mm/min.

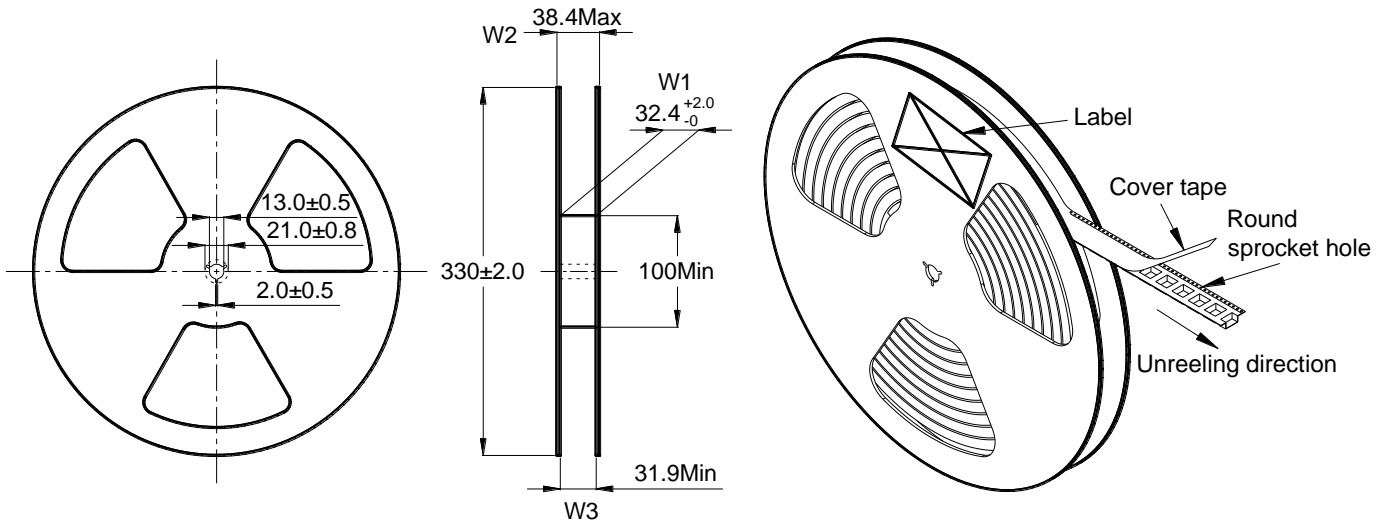
参考剥离速度 300±10mm/分钟。



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7.4 Reel dimensions (mm)

卷盘尺寸



7.5 Carton dimensions and packing quantity

包装箱尺寸和包装数量

■ Inner Carton: 340×340×95mm
内包装盒

■ Out Carton : 355×355×385mm
外包装箱

Product Series 产品系列	Quantity / Reel 数量 / 卷	Inner Carton Quantity 内盒 包装数量	Out Carton Quantity 外箱 包装总数量
FWP1809	150pcs	(150×2) = 300pcs	(300×3) = 900pcs

7.6 Label making

标签标识

The following items will be marked on the reel of product label and shipping label.
以下项目将明确标识于产品卷盘标签以及运输标签上。

Production Label 产品标签
■ Part No. 产品型号
■ Electrical Information 产品电性信息
■ Quantity 数量
■ Packing No. 包装流水号

Shipping Label 运输标签
■ Customer Name 客户名称
■ Customer Part No. 客户型号
■ Supplier Part No. 供应商型号
■ Supplier Name 供应商名称
■ Country of origin 产品产地

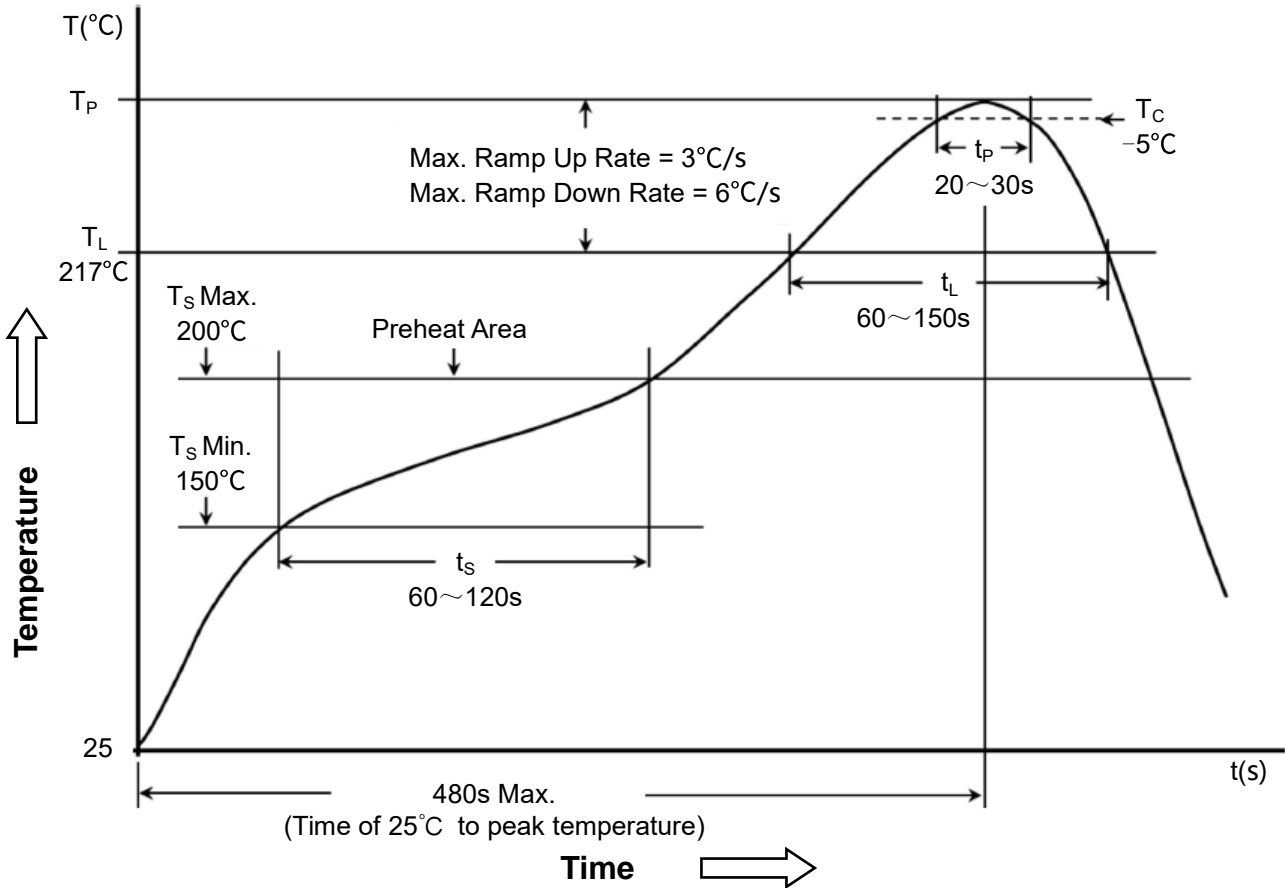
- FWP1809 Series

8 Soldering specification

焊接规格

8.1 Reflow profile for SMT components

SMT 回流焊温度曲线



8.2 Classification of peak package body temperature (Tp)

封装体峰值温度(Tp)分类

	Package Thickness 封装厚度	Package Volume 封装体积		
		<350 mm ³	350~2000 mm ³	>2000 mm ³
PB-Free Assembly 无铅装配	<1.6mm	260°C	260°C	260°C
	1.6~2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

※ Reflow is referred to standard IPC/JEDEC J-STD-020D.
回流焊参照标准 IPC/JEDEC J-STD-020D。